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Multispectral imaging via luminescent down-shifting with colloidal quantum dots

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Abstract: The high infrared quantum yield, continuous absorption spectrum, and band edge tunability of colloidal quantum dots (QD) has opened up new opportunities to use luminescent down shifting for multispectral imaging in the infrared. We demonstrate a QD sensitized short wavelength infrared (SWIR) camera which is capable of UV-SWIR multispectral imaging. The application of multispectral cameras for UV tagging applications is demonstrated and the extension of this technology to the mid infrared spectral region is discussed.

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References and Links


1. Introduction

Infrared imaging has been widely explored for civilian and military applications [1]. Of particular interest are the short wavelength infrared (SWIR, 1-2 um), mid wavelength infrared (MWIR, 3-5 um) and long wavelength infrared (LWIR, 8-12 um) spectral bands, due to the high atmospheric transparency in these regions. Each of these spectral bands can provide unique capabilities; for example, the SWIR band provides improved visibility over the visible region at night [2], the MWIR band is used for tracking high temperature objects [3], and the LWIR provides thermal imaging for lower temperature objects such as humans [1]. Significant progress has been made in the development of high efficiency and high resolution imaging arrays for each of these individual bands.

Multispectral imaging uses a single camera to acquire images of an object in multiple regions of the spectrum, such as ultraviolet-visible (UV-Vis), Vis-SWIR [2], or MWIR-LWIR [1]. The ability to detect and identify objects can be greatly enhanced by analyzing the differences between the images acquired in different spectral regions, and utilizing multiple spectral bands can also overcome limitations of individual bands [1]. Although utilizing multiple single band cameras can give broad spectral response, using a different camera for each spectral region increases cost, space requirements, and power consumption. In addition, data for each spectral region is taken from a different perspective. This has motivated the development of multispectral imaging arrays that are sensitive to broad spectral regions.
Although the technology for imaging arrays for each individual spectral region is relatively highly developed, challenges remain in the fabrication of multispectral imaging arrays that operate with high efficiency across broad spectral bands. For all semiconductor based imaging cameras, the long wavelength limit is set by the band gap of the material as the photons with energy below the band gap are not absorbed. The short wavelength cut off of the detector is due to higher energy photons being absorbed in inactive regions of the detector. For example, in the case of the flip chip technology employed by many camera designs, light is absorbed by the substrate due to the backside illumination geometry [2, 4]. In Si cameras, the processing circuitry may lie above the pixel and absorb high energy photons instead of the active region.

To date, multispectral imaging has been achieved using several different techniques. For flip-chip structures where the underlying substrate absorbs the spectrum of interest, the substrate can be mechanically thinned to reduce absorption. This strategy has been employed for Vis-SWIR InGaAs detectors [2, 4]. However, this method increases cost and performance in the blue and ultraviolet regions remains poor [2, 4]. Another approach is to fabricate two junctions with different band gaps in each pixel. This has been achieved by creating a n-p-n triple layer heterojunction structure and has been employed for MWIR-LWIR two color detectors, which has the advantage of being able to select the spectral region based on the applied bias without the use of filters [1]. The main drawback is the increase in complexity and cost.

In this paper we present the use of colloidal quantum dots (QD) for luminescent down-shifting to achieve multispectral imaging [5, 6]. This method offers a simple, low cost way to expand the low wavelength spectral range of a conventional single band detector. QDs are shown to dramatically increase the sensitivity of an InGaAs SWIR imager to ultraviolet light and the use of UV-SWIR imaging for spectrally resolved tagging applications is demonstrated. The application of QDs for extending the performance of MWIR or LWIR detectors in the SWIR, Vis and UV spectral regions is modeled and discussed.

2. Luminescent down-shifting with colloidal Quantum Dots

Colloidal quantum dots are semiconductor particles with a diameter less than 50 nm that are synthesized from organo-metallic precursors using solution-phase chemistry. Figure 1(a) depicts the structure of a colloidal QD. A coating of organic ligands serves to solubilize the QDs and helps to passivate the surface. Better passivation can be achieved by growing an inorganic shell of a higher band gap material around the QD core as depicted in Fig. 1(b). Figure 1(c) shows the absorption and emission spectra for a size series of infrared emitting PbS QDs. By tuning the QD size, quantum confinement shifts the energy of the bandgap relative to the bulk bandgap of the material.

When light above the QD bandgap is absorbed, the resulting electron-hole pair rapidly relaxes to the band edge. Due to the confinement of the particle, the electron and hole cannot spatially separate, and have a high probability of recombining via the emission of a photon at the band edge. The ratio of absorbed photons to emitted photons is known as the quantum yield (QY).
Figure 2(a) depicts the function of a QD down-shifting layer. Prior to deposition, the detector is sensitive to photons within its spectral range, but higher energy photons are absorbed outside of the active area of the detector. The QD layer is an electrically passive layer that absorbs incident photons above the band gap of the QD and re-emits the photons in the spectral range of the detector. The QDs can be embedded in a transparent polymer such as poly(methyl methacrylate) (PMMA) to improve the optical quality of the film [5]. Figure 2(b) shows the design of a QD enhanced imaging array. The bare imaging array consists of a focal plane array (FPA) that is attached to a read out integrated circuit (ROIC) via indium bumps. Following the fabrication of the imaging array, the QD layer is deposited on top of the FPA. This can be done by drop casting or spin coating to create a highly uniform layer [6].

Fig. 2. (a) Cartoon of the function of the down-shifting layer. (b) Incorporation of down-shifting layer onto imaging array.

Luminescent down-shifting with organic fluorophores has been used to enhance the spectral sensitivity of Si cameras in the blue and UV regions [7–9]. However, the QY of organic dyes decreases extremely rapidly in the SWIR. Although QY values of near unity can be obtained for emission in the visible spectrum, typical QY values are below 20% by 800 nm [10] and below 1% above 1000 nm [11]. QY for QDs emitting in the SWIR region of over 80% have been reported [12], extending the application of luminescent down shifting into the infrared region.

By tuning the size, the emission wavelength can be chosen to lie along the high energy edge of a standard, single spectrum imaging array. Figures 3(a)-3(c) show the absorption and emission spectrum of PbS QDs along with the relative quantum efficiency of three different SWIR or MWIR detectors. Figures 3(a) shows the relative quantum efficiency spectrum a standard InGaAs FPA [2] and the spectra for PbS QDs emitting at 1200 nm. Figure 3(b) shows the spectrum of PbS/CdS QDs and the response of a substrate thinned InGaAs FPA.
designed for Vis-SWIR dual band imaging [2]. Figure 3(c) shows the spectrum of a PbS QD emitting at 1550 nm and response curve of a HgCdTe SWIR-MWIR dual band imager [13].

From the absorption and emission profile of the QD and the quantum efficiency curve of the detector, the efficiency of the detector following the addition of a QD LDS layer can be modeled according to Eq. (1) [5],

\[
\frac{\eta(\lambda)}{\eta_{\text{max}}(\lambda)} = \left[1 - A(\lambda) \right] \frac{\eta_{\text{in}}(\lambda)}{\eta_{\text{out}}(\lambda)} + A(\lambda) \cdot QY \cdot CE \cdot \Theta_{\text{em}}
\]  

(1)

In Eq. (1), \(\eta(\lambda)/\eta_{\text{max}}(\lambda)\) is the relative efficiency of the bare detector at wavelength \(\lambda\), \(\eta(\lambda)/\eta_{\text{max}}(\lambda)\) is the calculated relative efficiency of the QD coated detector, and \(A(\lambda)\) is the absorption of the QD layer. On the right side of Eq. (1), QY is the average quantum yield of the QDs, CE is the collection efficiency of emitted photons, and \(\Theta_{\text{em}}\) is the overlap integral between the QD emission and the bare detector quantum efficiency.

By varying the concentration of QDs, \(A(\lambda)\) can be varied such that the QDs absorb strongly in the spectral band of interest. For example, in Fig. 3(a), \(A(\lambda)\) has been set such that the QDs absorb 95% of light between 250 and 400 nm. The overlap between the emission of the QDs and the bare detector, \(\Theta_{\text{em}}\), can be made near unity by tuning the QD size so that the emission overlaps with the high efficiency region of the detector as shown in Fig. 3(a). The limiting factors for performance of the down-shifting layer will therefore be the QY of the QDs and the collection efficiency, CE. For visible emitting CdSe/CdS QDs, quantum yields near 100% have been reported [14], and QYs of 80% have been obtained for SWIR emitting PbS QDs [12]. The QY of MWIR emitting QDs is discussed below. Although the QDs emit isotropically, since the index of refraction of the down-shifting layer is greater than air there is a high probability that photons emitted away from the FPA will be reflected back towards the FPA at the interface between the QD layer and air. The CE for a QD down-shifting layer with an averaged index of refraction of 1.6 is calculated to be 90% using the Fresnel equations [5].

Figures 3(d)-(f) show the calculated QE for the spectra shown in Fig. 3(a)-(c) using Eq. (1). For these calculations, a quantum yield of 80% has been used along with a collection efficiency of 90%. For the standard InGaAs FPA (Fig. 3(d)), a dramatic increase in UV sensitivity can be obtained, since the bare FPA has essentially no UV sensitivity. Even in the
case of the substrate thinned FPA that is designed for Vis performance (Fig. 3(e)), a large increase in both the Vis and UV spectral regions can be achieved to realize a UV-Vis-SWIR multispectral imager [6]. Figure 3(f) demonstrates that PbS QDs can be used to extend the spectral range of any detector that has high quantum efficiency in some portion of the SWIR region.

3. UV-SWIR Multispectral Imaging

To demonstrate the effect of the QD down-shifting layer, half of an InGaAs SWIR FPA was coated with a layer of PbS QDs in PMMA and half of the FPA was left bare. The FPA was manufactured by Raytheon Vision Systems and consists of 1280 x 1024 pixels with a 20 μm pixel pitch. The QD enhanced detector was put in a standard InGaAs camera housing and a CoastalOpt UV-Vis-IR 60 mm lens was used to reduce achromatic dispersion [6]. Figures 4(a) and 4(b) show two images from a video available online that was taken with our UV-SWIR camera at 30 frames per second. The red line separates the left half of the image which was taken with the QD coated FPA and the right half of the image which was taken with the bare FPA. In both images, the UV tag is on; however, it is not visible when imaged with the bare FPA because the UV sensitivity is so poor. When imaged with the QD coated portion it is clearly visible due to the dramatic increase in UV sensitivity. Figure 4(c) shows a single frame from a video available online which demonstrates the application of this technology for UV tagging in poor visibility situations.

Figure 5 demonstrates the use of an ultraviolet tag in an area with large amounts of background visible and infrared sources. One challenge with using a SWIR or MWIR light emitting device (LED) as a tag or communication device is that there is a large amount of natural background in these regions. If a UV LED is used, particularly one emitting in the solar blind region between 200 and 280 nm, there is minimal background, improving the ability to detect the LED [15].

Figure 5. Example of using multispectral imaging to identify position of tag. In image (a), a large visible and infrared background makes identification of tag difficult. In (b), a UV pass filter dramatically reduces visible and infrared response. Basic image processing can be used to generate image (c), in which the tag location is clearly identified above the background.
In Fig. 5(a), when both the UV and SWIR light is collected, identification of the tag over the background is not possible. In Fig. 5(b), a UV-pass filter (UG11 Schott glass) blocks the majority of the infrared light, revealing the location of the tag. Combining the spectra in Fig. 5(a) and 5(b), the high contrast image showing only the tag location shown in Fig. 5(c) was calculated using basic image processing according to Eq. (2),

\[
I_{\text{proc}} = \left( I_{\text{UV}} - \frac{I}{2} \right)
\]

where \( T_{\text{UV}} \) is the average filter transmission in the UV pass band, \( I_{\text{proc}} \) is the processed image, \( I \) is the image without the UV pass filter, and \( I_{\text{UV}} \) is the filtered image. Equation (2) removes residual Vis and SWIR signal where the intensity has dropped by more than \( T_{\text{UV}}/2 \) when the UV pass filter is added.

The maximum frame rate of the camera will be limited by the bandwidth of the QD down-shifting layer. The bandwidth is determined by the lifetime of the QDs [5]. For visible CdSe/CdS QDs, lifetimes on the order of 10 ns are typical, which allows for approximately 15 MHz frame rates. The lifetime of PbS QDs is on the order of 1 us, giving a maximum frame rate of approximately 150 kHz. Figure 6 shows the response of a single pixel InGaAs detector (Hamamatsu Corporation #G8941-01) coated with PbS QDs to a 285 nm LED encoding a digital signal with a bit frequency of 10 kHz.

The UV band is of interest for communication due to the low levels of background light in the solar blind region between 200 and 280 nm [15]. A high speed SWIR camera coated with QDs has the potential to both locate UV tags within a SWIR image and receive UV communications at rates up to 150 kHz. For example, this could be used for distinguishing between multiple UV tags within a scene.

4. Outlook for MWIR Emitting QDs

Significant effort has gone into the development and characterization of QDs that emit in the visible and SWIR spectral regions due to the commercial interest in visible LEDs [16], luminescent down shifting for white lighting [17], and biological tagging in the SWIR band [18]. Until recently, the only QD material available for MWIR emission was PbSe [19]. However, recently several syntheses have been reported for MWIR emitting QDs, including Cd₃As₂ [20], InSb [21] and HgTe [22] QDs which greatly extend the available material set for MWIR applications. Figure 7 shows the calculated effect of a QD down-shifting layer composed of HgTe QDs [22] on a LWIR detector [23].
Fig. 7. Model of effect of MWIR emitting HgTe QDs [22] on the spectral response of a LWIR detector. QD absorption spectrum (dark blue line), emission spectrum (light blue line, arbitrary units) are shown along with the detector relative efficiency before addition of the QD layer (black line). The effect of the QD down-shifting layer is modeled the QY values noted on the graph above the red to yellow lines. Dashed lines are extrapolations from published data.

As Fig. 7 shows, MWIR emitting QDs show promise for ultra broad band spectral imaging. The main challenge of extending this technique into the MWIR will be to ensure a high quantum yield for the QDs. Typical synthetic methods to make quantum dots involves coating the QDs with organic ligands, as depicted in Fig. 1(a). Although these ligands serve to passivate the surface and improve the QY in the visible region, in the infrared the exciton may couple to vibrational states associated with the organic molecules leading to non-radiative recombination of the exciton [11, 24]. Therefore methods to isolate the exciton from the organic ligands are required to obtain high QY in the MWIR.

One method is to grow high quality core/shell structures that effectively to isolate the exciton from the surface. This has been achieved in the visible region with the synthesis of highly epitaxial shells that suppress blinking by isolating the exciton from the QD surface [25, 26]. Alternately, typical organic ligands may be replaced with infrared transparent fluorinated ligands [24] or with inorganic ligands [27, 28]. Another recent development is the encapsulation of QDs within an inorganic matrix [29–32]. Although a thin coating of PMMA will absorb only weakly in the MWIR region, embedding the QDs in an inorganic matrix that is completely transparent across the MWIR may improve performance and further remove the exciton from organic material.

Even if the exciton is isolated from non-radiative decay pathways associated with surface defects and organic ligands, non-radiative interband relaxation may still limit the QY of small bandgap MWIR QDs. The interband non-radiative decay rate will increase with decreasing bandgap, and may present a fundamental limit on the QY for MWIR QDs. However, MWIR and LWIR detectors are commonly cooled to reduce noise, which will decrease both the temperature of the QD coating and the non-radiative interband relaxation rate. Further experimental and theoretical work is necessary to determine the fundamental limit of the QY for MWIR emitting QDs.

5. Conclusion

We have demonstrated the use of colloidal quantum dots to extend the spectral range of an infrared detector to the ultraviolet band. The high infrared quantum yield and tunable band gap of the QDs make them uniquely suited for use as a luminescent down-shifter. The QDs can be deposited after assembly of the imaging array using low cost techniques. As synthetic techniques improve, high QY QDs emitting in the MWIR band may provide a convenient source of infrared light for a variety of applications.
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